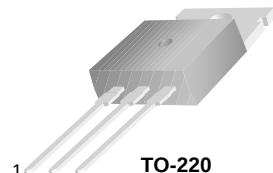


D45C8

PNP Power Amplifier

- Sourced from process 5P.



TO-220
1. Base 2. Collector 3. Emitter

Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	-60	V
I_C	Collector Current - Continuous	-4.0	A
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

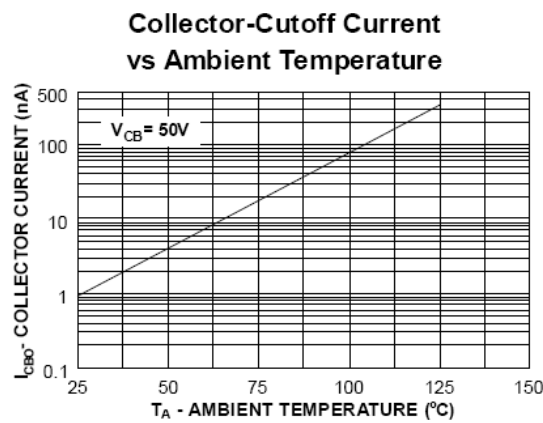
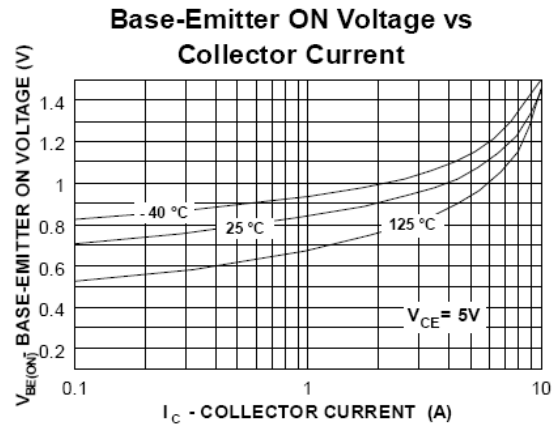
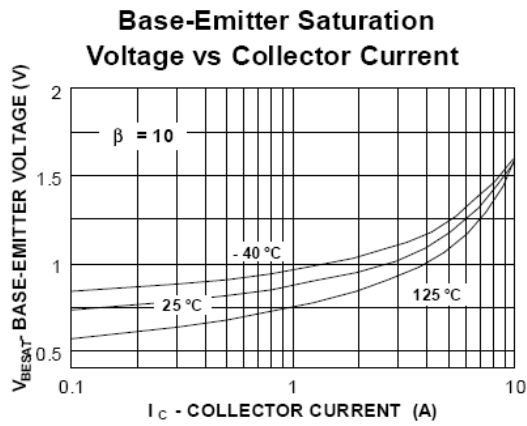
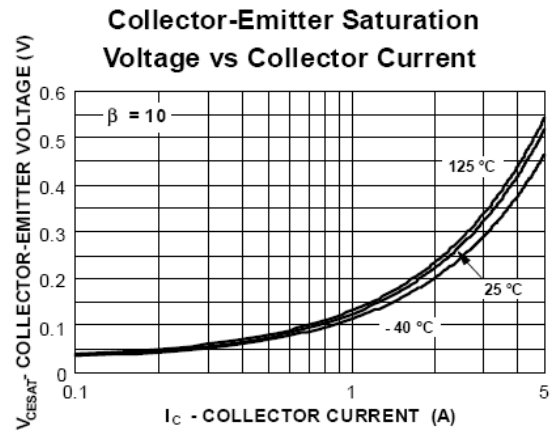
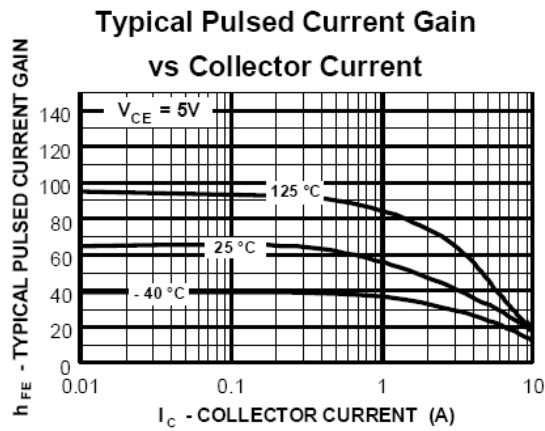
Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristics						
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage	$I_C = -100\text{mA}, I_B = 0$	-60			V
I_{CES}	Collector-Emitter-(Base)Short	$V_{CE} = -70\text{V}, I_E = 0$			-10	μA
I_{CEO}	Collector-Emitter-(Base)Open	$V_{CE} = -55\text{V}, I_E = 0$			-100	μA
I_{EBO}	Emitter-Base Current	$V_{EB} = -5.0\text{V}, I_B = 0$			-100	μA
On Characteristics						
h_{FE}	DC Current Gain	$V_{CE} = -1.0\text{V}, I_C = -0.2\text{A}$ $V_{CE} = -1.0\text{V}, I_C = -2.0\text{A}$	40 20		120	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = -1.0\text{A}, I_B = -50\text{mA}$			-0.5	V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = -1.0\text{A}, I_B = -100\text{mA}$			-1.3	V
Small Signal Characteristics						
C_{ob}	Output Capacitance	$V_{CB} = -10\text{V}, f = 1.0\text{MHz}$			125	pF
f_T	Current Gain Bandwidth Product	$I_C = -20\text{mA}, V_{CE} = -4.0\text{V}$	32			MHz
t_{ON}	t_d , Delay Time t_r , Rise Time	$I_C = -1.0\text{A},$ $I_{B1} = I_{B2} = -0.1\text{A}$		59 502		ns
t_{OFF}	t_s , Storage Time t_f , Fall Time	$V_{CC} = -30\text{V}, t_p = 25\mu\text{s}$		474 59		ns

Thermal Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Max.	Units
P_D	Total Device Dissipation Derate above 25°C	60 480	W $\text{mW}/^\circ\text{C}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.1	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	$^\circ\text{C}/\text{W}$

Typical Performance Characteristics





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Definition of Terms

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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